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| FORM PTO-1449<br><br><b>LIST OF PATENTS AND PUBLICATIONS FOR<br/>APPLICANT'S INFORMATION DISCLOSURE<br/>STATEMENT</b><br><br>(use several sheets if necessary) | SERIAL NO.<br>10/047,469        | CASE NO.<br>10322-31   |
|  | FILING DATE<br>January 15, 2002 | GROUP ART UNIT<br>2817 |
|  | APPLICANTS: J. Gary Eden et al. |                        |

REFERENCE DESIGNATION U.S. PATENT DOCUMENTS

| EXAMINER<br>INITIAL |    | DOCUMENT<br>NUMBER | DATE    | NAME              | CLASS/<br>SUBCLASS | FILING<br>DATE |
|---------------------|----|--------------------|---------|-------------------|--------------------|----------------|
| D.D.                | A1 | 6,016,027          | 01/2000 | DeTemple et al.   |                    |                |
| D.D.                | A2 | 5,686,789          | 11/1997 | Schoenbach et al. |                    |                |
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FOREIGN PATENT DOCUMENTS

| EXAMINER<br>INITIAL |    | DOCUMENT<br>NUMBER | DATE    | COUNTRY | CLASS/<br>SUBCLASS | TRANSLATION<br>YES NO |
|---------------------|----|--------------------|---------|---------|--------------------|-----------------------|
| D.D.                | A3 | JP 7,192,701       | 07/1995 | Japan   |                    | X<br>(Partial)        |
|                     |    |                    |         |         |                    |                       |
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| EXAMINER<br>INITIAL | OTHER ART (Including Author, Title, Date, Pertinent Pages, etc.) |  |
|---------------------|--|--|
| D.D.                | A4   | "High-Pressure Hollow Cathode Discharges;" Karl H. Schoenbach et al.; Physical Electronics Research Institute, Old Dominion University, Norfolk, VA, USA; 6-30-1997.   |
| D.D.                | A5   | "Microdischarge Devices Fabricated in Silicon;" J.W. Frame et al.; Department of Electrical and Computer Engineering, Everett Laboratory, University of Illinois, Urbana, Illinois, USA; 6-30-1997; App. Phys. Lett. 71 (9), 1 September 1997.   |
| D.D.                | A6   | "Flexible Microdischarge Arrays: Metal/Polymer Devices;" S.-J. Park et al.; Laboratory for Optical Physics and Engineering, Department of Electrical and Computer Engineering, University of Illinois, Urbana, Illinois, USA; 5-17-2000; Applied Physics Letters, Volume 77, Number 2, 10 July 2000.                                 |
| D.D.                | A7   | "Emission of Excimer Radiation from Direct Current, High-Pressure Hollow Cathode Discharges;" Ahmed El-Habachi and Karl H. Schoenbach; Electrical and Computer Engineering Department, Physical Electronics Research Institute, Old Dominion University, Norfolk, Virginia, USA; 11-4-1997; App. Phys. Lett. 72 (1), 5 January 1998. |
| D.D.                | A8   | "Performance of Microdischarge Devices and Arrays with Screen Electrodes;" S.-J. Park, C.J. Wagner, and J. G. Eden, Fellow, IEEE; IEEE Photonics Technology Letters, Vol. 13, No. 1, January 2001.   |
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| EXAMINER<br> | DATE CONSIDERED<br>11/20/04 |
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EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.